

# WTC

## WMF8N70U POWER MOSFET

### Winsem Technology Corp.

#### 700V N-Channel Power MOSFET

#### Features

- High Voltage:  $BV_{DSS}=700V$ (Min.)
- $I_D : 8A$
- Robust high voltage termination
- Avalanche energy specified
- Fast diode recovery time



#### Application

- Ballast Bridge
- Switch Mode Power Supplier
- Power Factor Correction
- Lighting

#### Ordering Information

| Type NO  | Marking | Package Code |
|----------|---------|--------------|
| WMF8N70U | 8N70FU  | TO-220F      |



#### Absolute maximum ratings ( $T_C=25^\circ C$ unless otherwise noted)

| Characteristic               | Symbol    |                   | Rating   | Unit       |
|------------------------------|-----------|-------------------|----------|------------|
| Drain-source voltage         | $V_{DSS}$ |                   | 700      | V          |
| Gate-source voltage          | $V_{GSS}$ |                   | $\pm 30$ | V          |
| Drain current (DC) *         | $I_D$     | $T_C=25^\circ C$  | 8.0      | A          |
|                              |           | $T_C=100^\circ C$ | 5.06     | A          |
| Drain current (Pulsed) *     | $I_{DM}$  |                   | 32       | A          |
| Single avalanche energy      | (2)       | $E_{AS}$          | 275      | mJ         |
| Repetitive avalanche current |           | $I_{AR}$          | 8.0      | A          |
| Repetitive avalanche energy  | (1)       | $E_{AR}$          | 3.2      | mJ         |
| Power dissipation            |           | $P_D$             | 32       | W          |
| Junction temperature         | $T_J$     |                   | 150      | $^\circ C$ |
| Storage temperature range    | $T_{stg}$ |                   | -55~150  | $^\circ C$ |

\* Limited by maximum junction temperature

| Characteristic     | Symbol           | Typ.          | Max | Unit |
|--------------------|------------------|---------------|-----|------|
| Thermal resistance | Junction-case    | $R_{th(J-C)}$ | -   | 3.9  |
|                    | Junction-ambient | $R_{th(J-A)}$ | -   | 62.5 |

**Electrical Characteristics ( $T_C=25^\circ\text{C}$  unless otherwise noted)**

| Characteristic                 | Symbol                   | Test Condition   | Min. | Typ. | Max.      | Unit          |
|--------------------------------|--------------------------|--|------|------|-----------|---------------|
| Drain-source breakdown voltage | $\text{BV}_{\text{DSS}}$ | $I_D=250 \mu\text{A}, V_{GS}=0\text{V}$                    | 700  | -    | -         | V             |
| Gate threshold voltage         | $V_{GS(\text{th})}$      | $I_D=250 \mu\text{A}, V_{DS}=V_{GS}$                       | 3.0  | -    | 5.0       | V             |
| Drain-source cut-off current   | $I_{DSS}$                | $V_{DS}=700\text{V}, V_{GS}=0\text{V}$                     | -    | -    | 1         | $\mu\text{A}$ |
|                                |                          | $V_{DS}=700\text{V}, T_c=150^\circ\text{C}$                |      |      | 100       | $\mu\text{A}$ |
| Gate leakage current           | $I_{GSS}$                | $V_{DS}=0\text{V}, V_{GS}=\pm 30\text{V}$                  | -    | -    | $\pm 100$ | nA            |
| Drain-source on-resistance     | $R_{DS(\text{on})}$      | $V_{GS}=10\text{V}, I_D=4\text{A}$                         | -    | 0.85 | 1.05      | $\Omega$      |
| Forward transfer conductance ③ | $g_{fs}$                 | $V_{DS}=10\text{V}, I_D=4\text{A}$                         | -    | 10   | -         | S             |
| Input capacitance              | $C_{iss}$                | $V_{DS}=25\text{V}, V_{GS}=0\text{V}$<br>$f=1 \text{ MHz}$ | -    | 2190 | -         | pF            |
| Output capacitance             | $C_{oss}$                |  | -    | 135  | -         |               |
| Reverse transfer capacitance   | $C_{rss}$                |  | -    | 12.5 | -         |               |
| Turn-on delay time ③④          | $t_{d(\text{on})}$       | $V_{DS}=350\text{V}, I_D=8\text{A}$<br>$R_G=25\Omega$      | -    | 109  | -         | ns            |
| Rise time ③④                   | $t_r$                    |  | -    | 47   | -         |               |
| Turn-off delay time ③④         | $t_{d(\text{off})}$      |  | -    | 220  | -         |               |
| Fall time ③④                   | $t_f$                    |  | -    | 31   | -         |               |
| Total gate charge ③④           | $Q_g$                    | $V_{DS}=560\text{V}, V_{GS}=10\text{V}$<br>$I_D=8\text{A}$ | -    | 33   | 40        | nC            |
| Gate-source charge ③④          | $Q_{gs}$                 |  | -    | 12.5 | -         |               |
| Gate-drain charge ③④           | $Q_{gd}$                 |  | -    | 8    | -         |               |

**Source-Drain Diode Ratings and Characteristics ( $T_C=25^\circ\text{C}$  unless otherwise noted)**

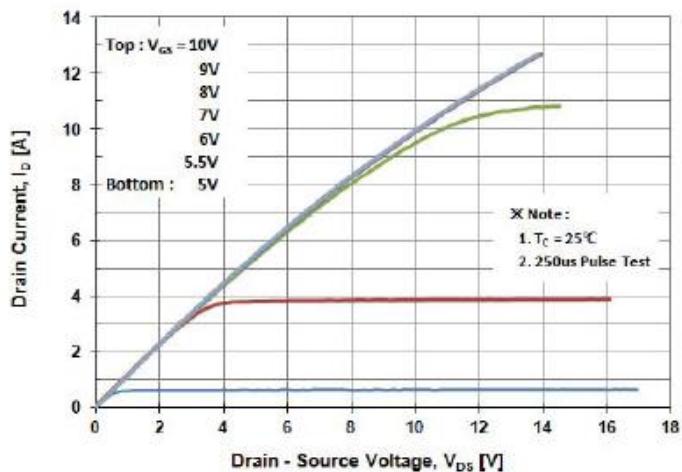
| Characteristic             | Symbol   | Test Condition  | Min | Typ | Max  | Unit          |
|----------------------------|----------|---|-----|-----|------|---------------|
| Source current (DC)        | $I_S$    | Integral reverse diode<br>in the MOSFET                                   | -   | -   | 8.0  | A             |
| Source current (Pulsed)    | $I_{SM}$ |   | -   | -   | 32.0 |               |
| Forward voltage            | $V_{SD}$ | $V_{GS}=0\text{V}, I_{SD}=8\text{A}$                                      | -   | -   | 1.4  | V             |
| Reverse recovery time ③④   | $t_{rr}$ | $I_{SD}=8\text{A}, V_{GS}=0\text{V}$<br>$dI_f/dt=100\text{A}/\mu\text{s}$ | -   | 500 | -    | ns            |
| Reverse recovery charge ③④ | $Q_{rr}$ |   | -   | 3.0 | -    | $\mu\text{C}$ |

Note :

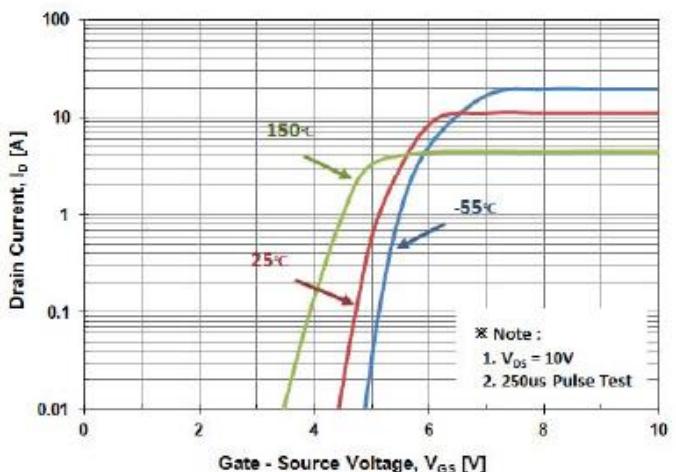
1. Repetitive rating : Pulse width limited by safe operating area
2.  $L=8\text{mH}, I_{AS}=8\text{A}, V_{DD}=50\text{V}, R_G=25 \Omega$ , Starting  $T_J=25^\circ\text{C}$
3. Pulse Test : Pulse width  $\leq 300 \mu\text{s}$ , Duty cycle  $\leq 2\%$
4. Essentially independent of operating temperature typical characteristics

## Electrical Characteristic Curves

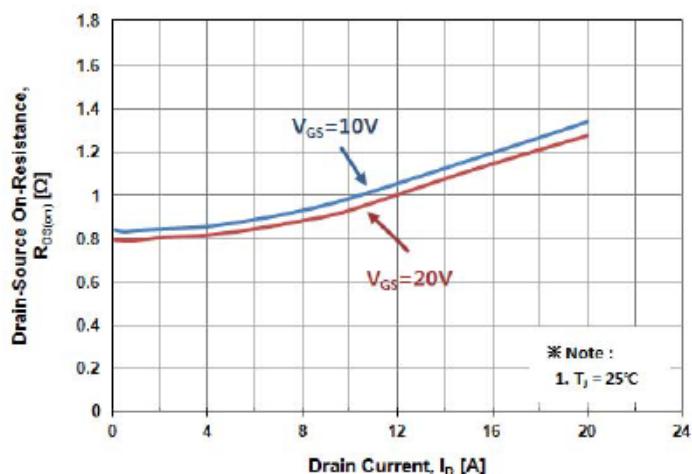
**Fig. 1 Typical Output Characteristics**



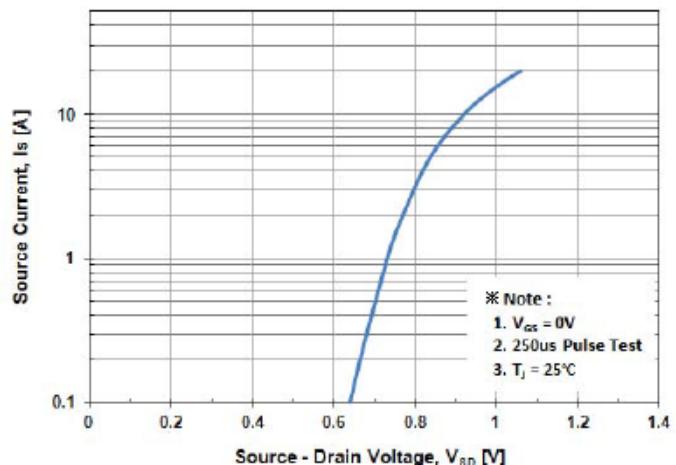
**Fig. 2 Typical Transfer Characteristics**



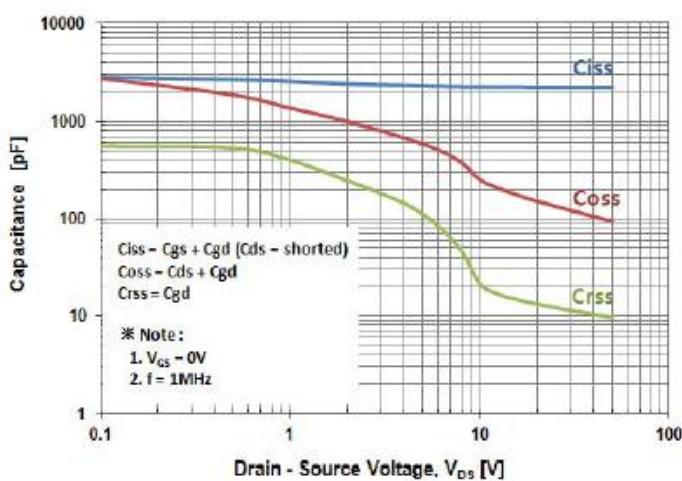
**Fig. 3 On-Resistance Variation with Drain Current and Gate Voltage**



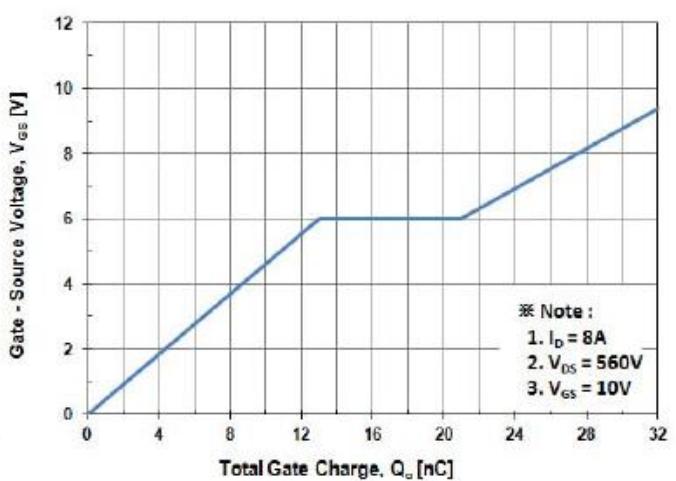
**Fig. 4 Body Diode Forward Voltage Variation with Source Current**



**Fig. 5 Typical Capacitance Characteristics**

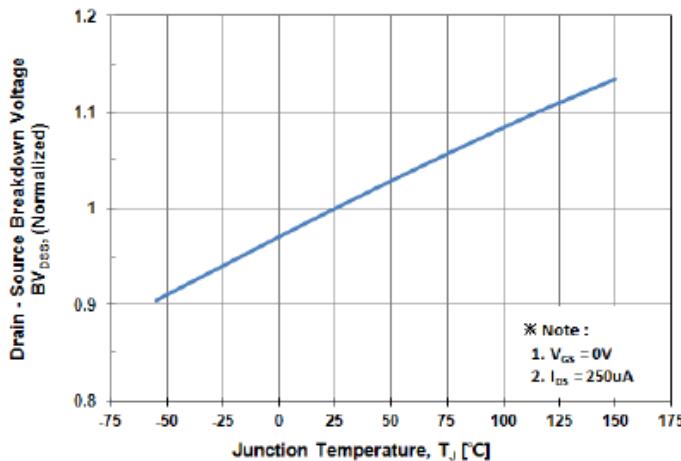


**Fig. 6 Typical Total Gate Charge Characteristics**

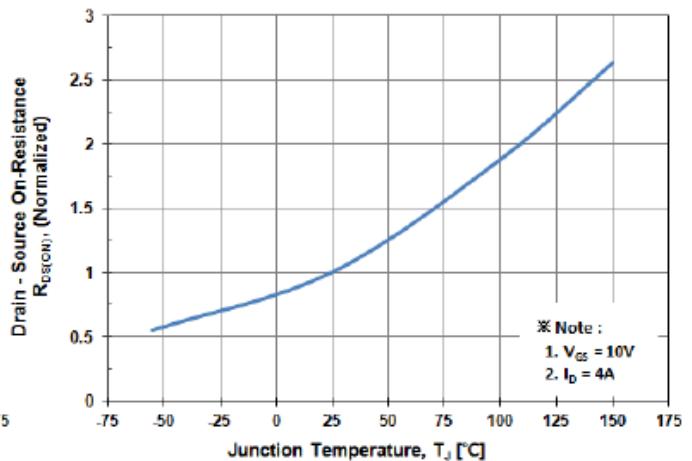


## Electrical Characteristic Curves

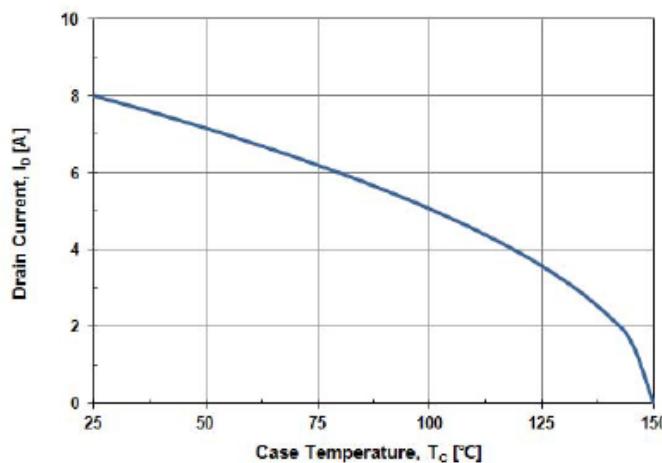
**Fig. 7 Breakdown Voltage Variation vs. Temperature**



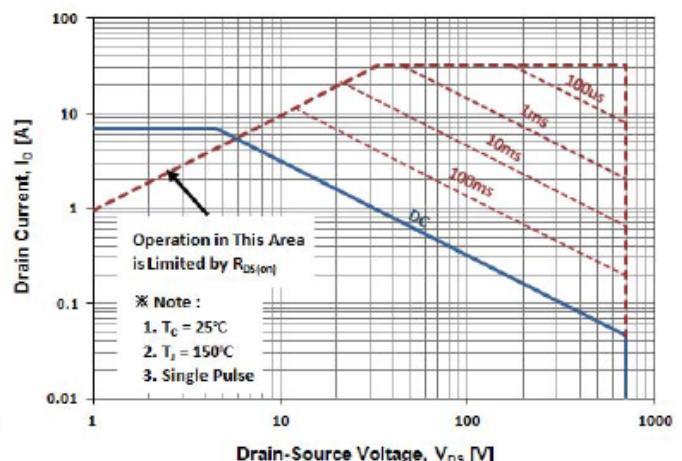
**Fig. 8 On-Resistance Variation vs. Temperature**



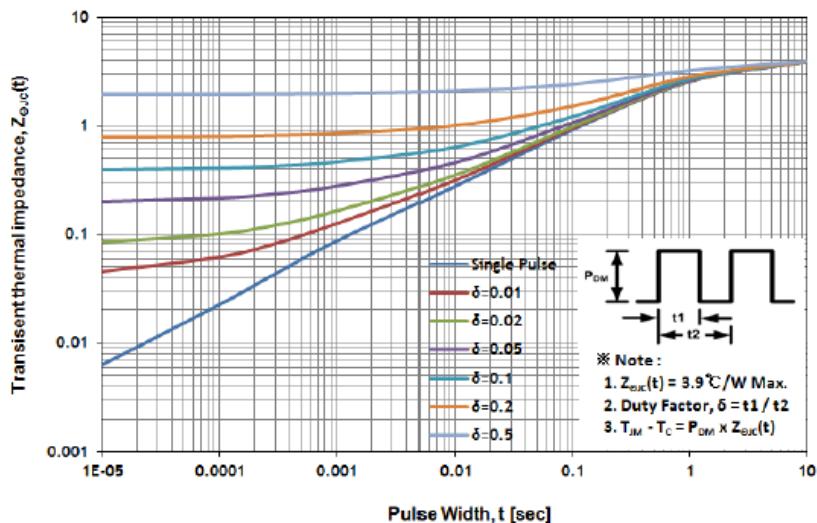
**Fig. 9 Maximum Drain Current vs. Case Temperature**

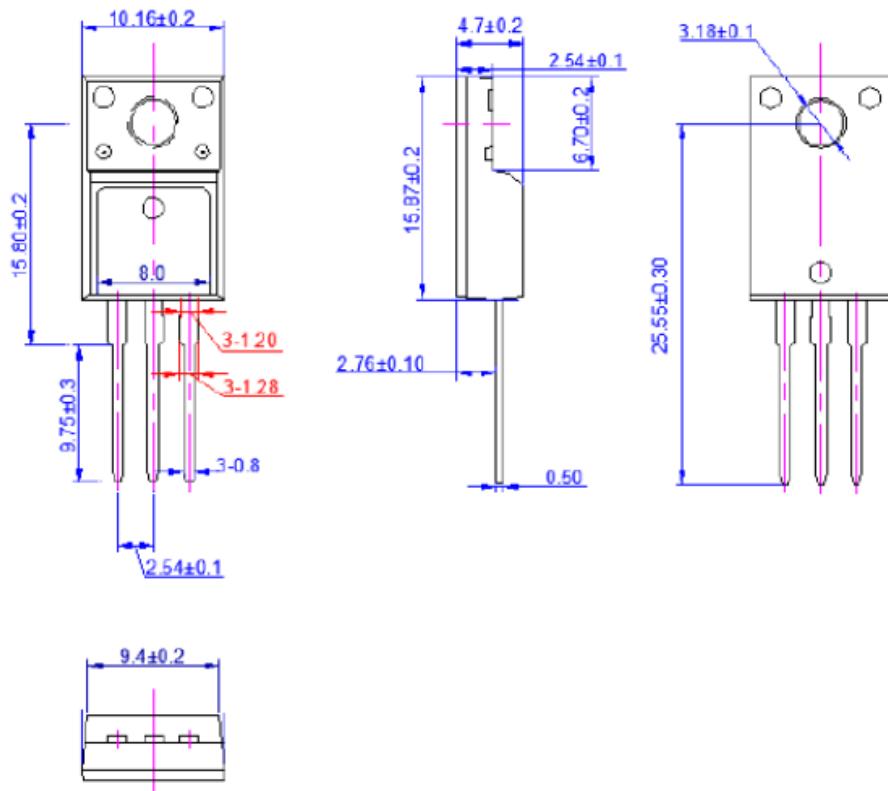


**Fig. 10 Maximum Safe Operating Area**

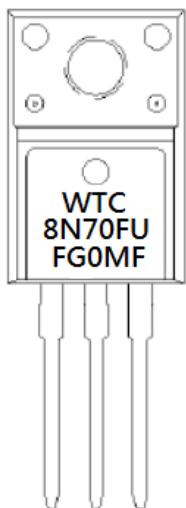


**Fig. 11 Transient Thermal Impedance**



Outline Dimension : TO-220F

Unit : mm

Marking Diagram

|             |        |                      |   |
|-------------|--------|----------------------|---|
| First Line  | WTC    | Company Name         |   |
| Second Line | 8N70FU | Product Code         |   |
| Third Line  | FG0MF  | 1st ( Year Code )    | A-2010 B-2011 C-2012 ...  |
|             |        | 2nd ( Month Code )   | A-Jan B-Feb C-Mar D-Apr E-May F-Jun G-Jul H-Aug I-Sep J-Oct K-Nov L-Dec |
|             |        | 3rd ( Lot Code )     | 0-1 , A-9   |
|             |        | 4th ( Product Code ) | M-MOS , T-Transistor  |
|             |        | 5th ( Package Code ) | X-TO-220, F-TO-220F   |
|             |        | 6th ( Spec Code )    | ( Reserve )   |